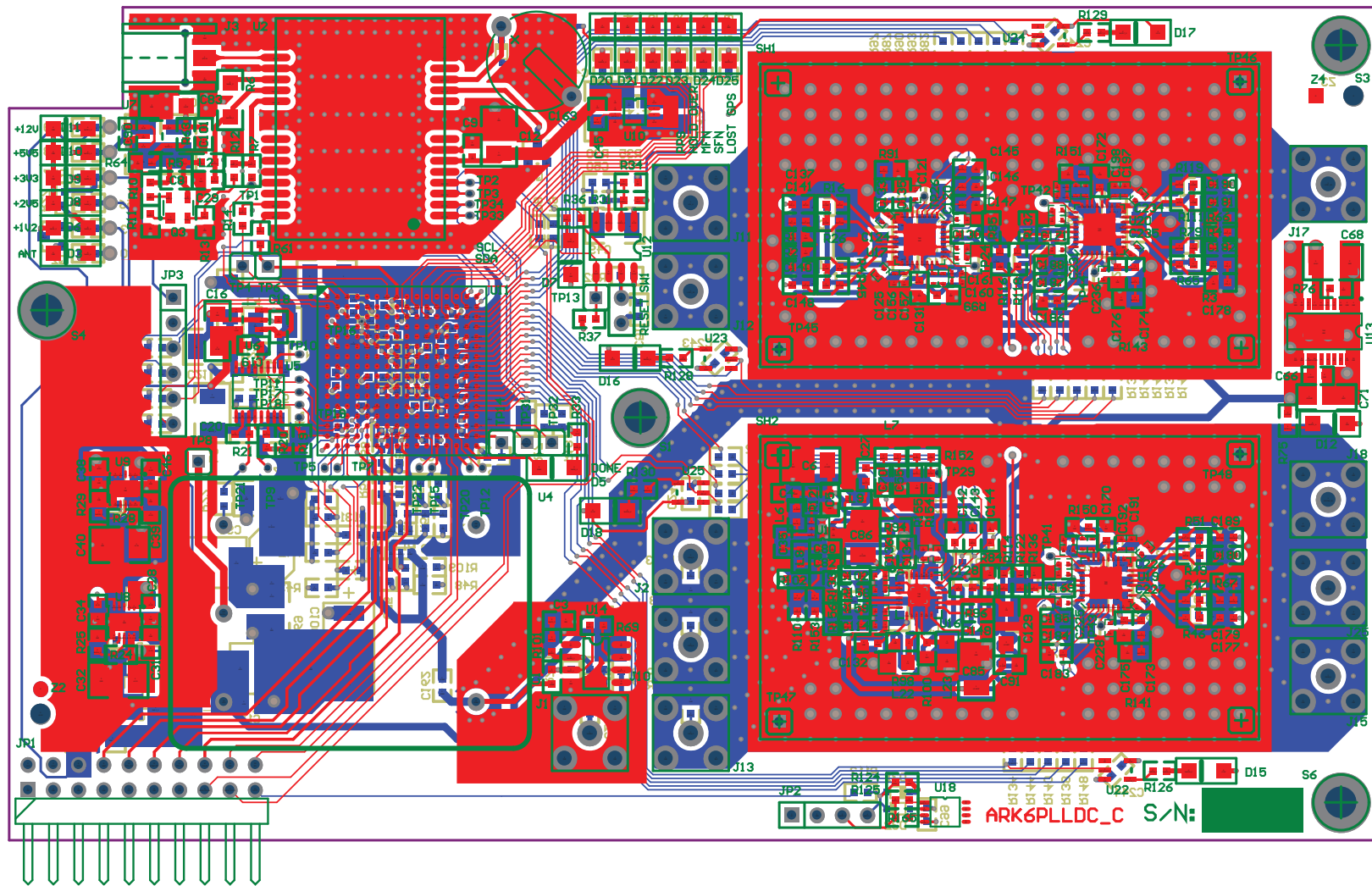




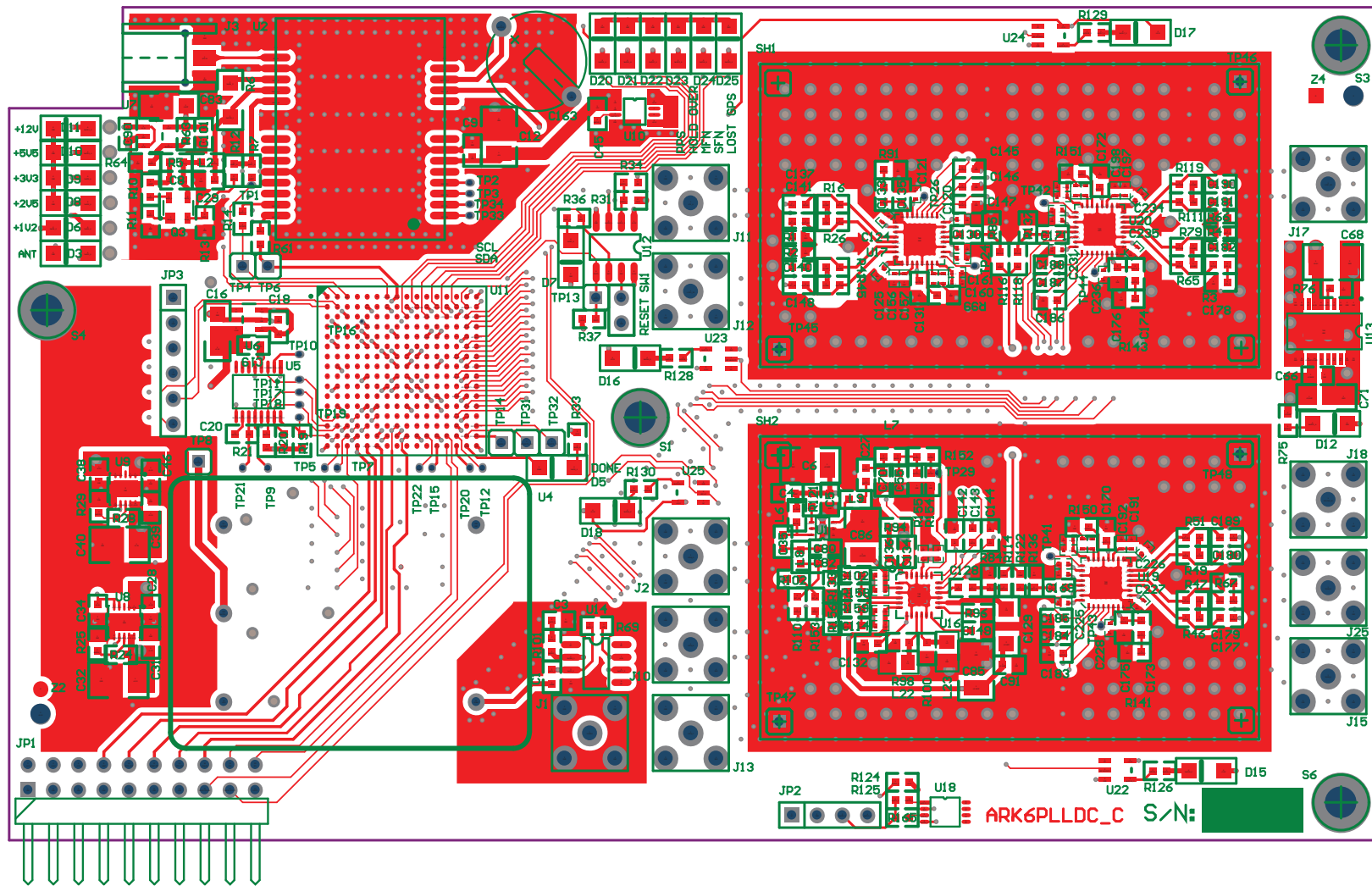
Top Layer
Top Overlay

Bottom Layer
Bottom Overlay

Keep-Out Layer

Layer Stack Up Detail for: ARK6PLLDC_C.PCBDOC

Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Type
Top Layer	(.GTL)	0.035mm		
InternalPlane1 (.GP1)		0.035mm	0.18mm	Core
MidLayer1	(.G1)	0.035mm	0.6mm	PrePreg
Bottom Layer	(.GBL)	0.035mm	0.6mm	Core

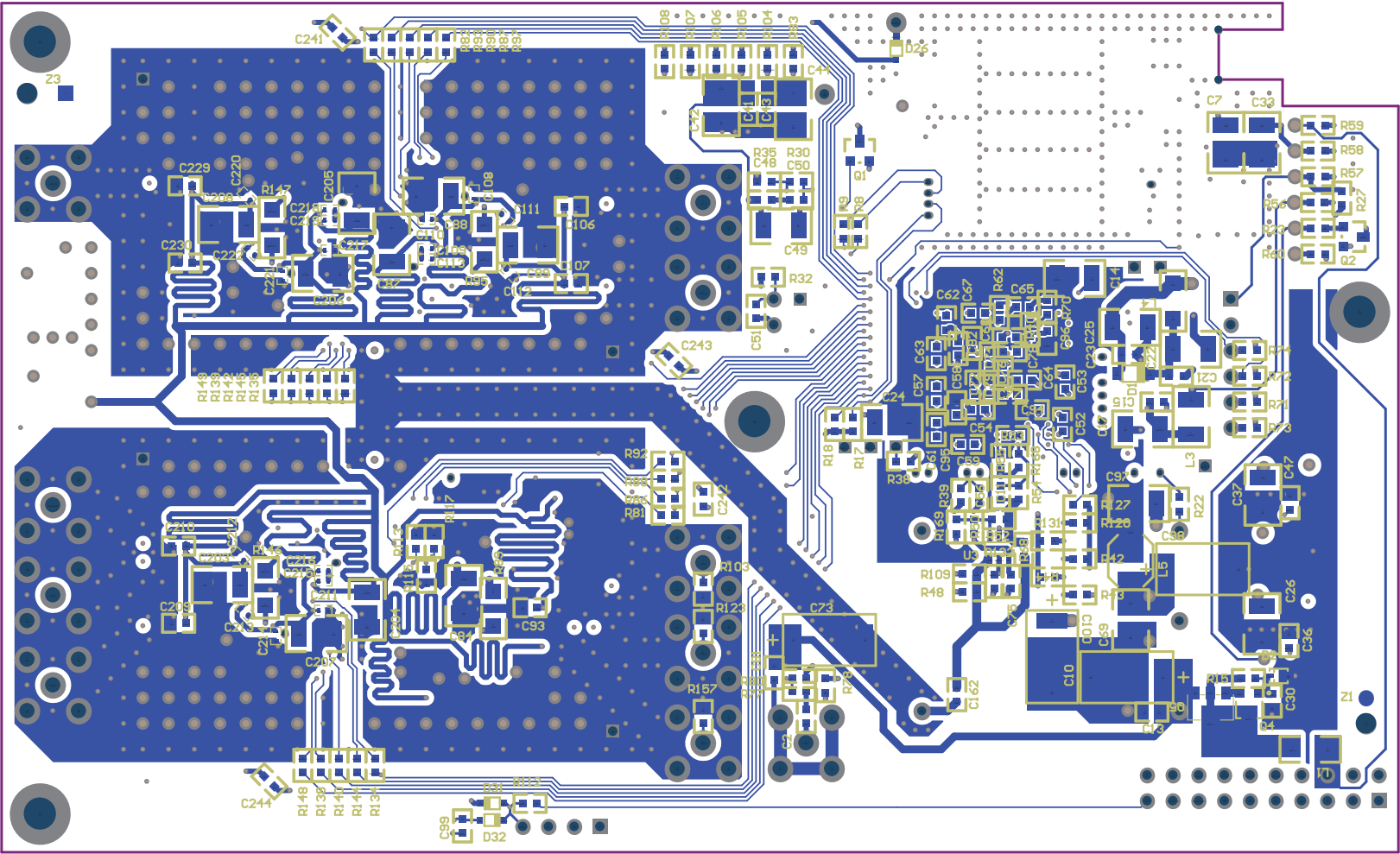


Top Layer
Top Overlay

Keep-Out Layer

Layer Stack Up Detail for: ARK6PLLDC_C.PC8DOC

Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Type
Top Layer	(.6TL)	0.035mm		
InternalPlane1 (.6P1)		0.035mm	0.18mm	Core
MidLayer1	(.61)	0.035mm	0.6mm	PrePreg
Bottom Layer	(.6BL)	0.035mm	0.6mm	Core



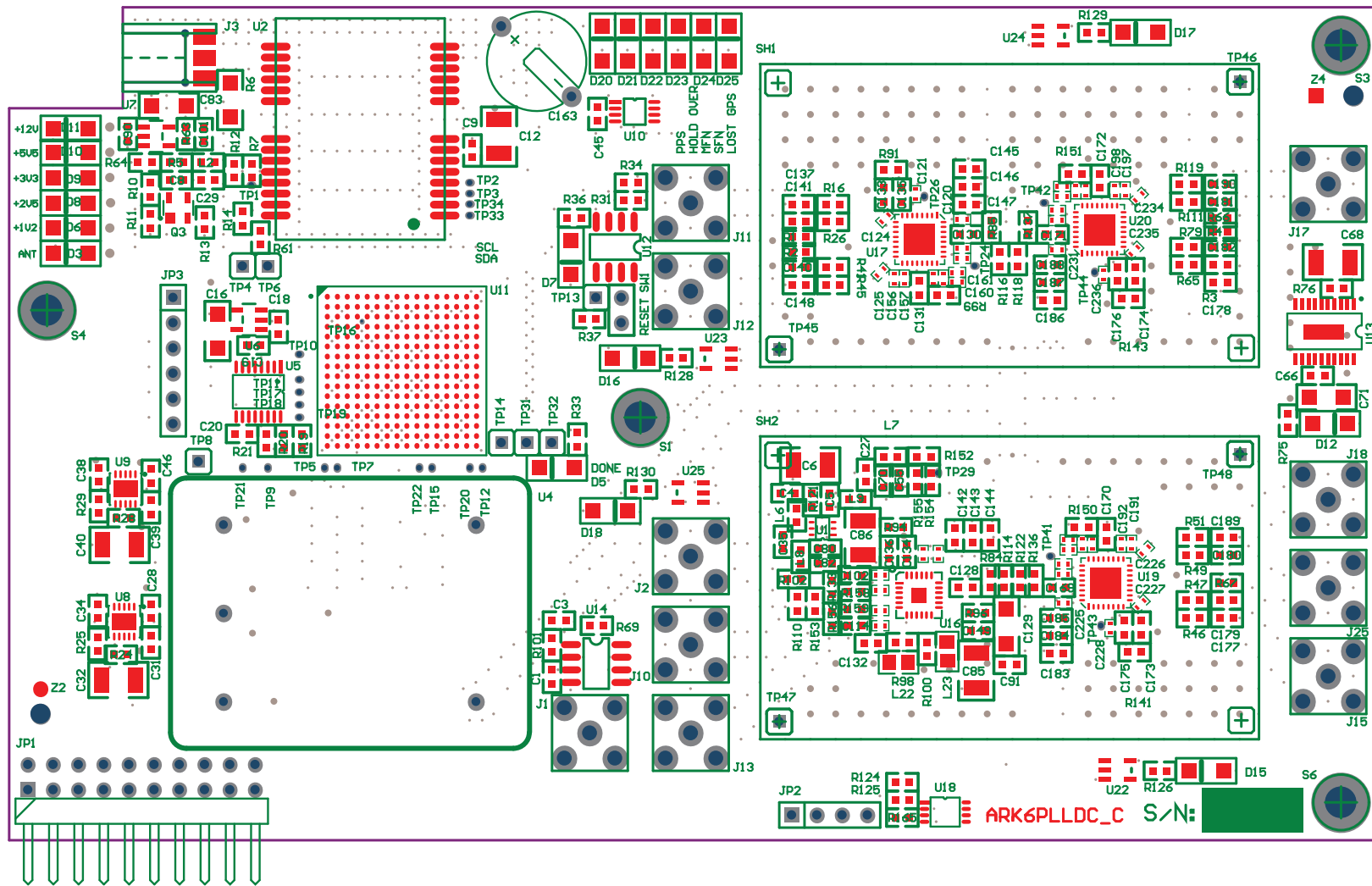
Layer Stack Up Detail for: ARKBP_LLC_C_PCBDOC

Layer Name	Document	Copper Thickness	Dielectric Height	Dielectric Type
Top Layer	(.GTL)	0.035mm	0.18mm	Core
Internal Plane1 (.GPI)		0.035mm	0.0mm	Prepreg
Middle Layer1 (.GL)		0.035mm	0.0mm	Core
Bottom Layer (.GBL)		0.035mm		

Bottom Layer
Bottom Overlay

Keep-Out Layer

Keep-Out Layer



Top Layer
Top Overlay

Keep-Out Layer

Layer Stack Up Detail for: ARK6PLLDC_C.PCBD0C

Layer Name	Gerber Document	Copper Thickness	Dielectric Height	Dielectric Type
Top Layer	(.6TL)	0.035mm		
InternalPlane1	(.6P1)	0.035mm	0.18mm	Core
MidLayer1	(.61)	0.035mm	0.6mm	PrePreg
Bottom Layer	(.6BL)	0.035mm	0.6mm	Core